Thermal Management Solutions

Technical Data Sheet



Page 1

HTCPX_TRW Non-Silicone Heat Transfer Compound Plus – Xtra

HTCPX_TRW provides the ultimate in thermal conductivity in a non-curing paste, designed for use as a gap filling material. It is recommended where the efficient and reliable thermal coupling of electronic components or heat dissipation is required. HTCPX_TRW is a non-silicone paste, suitable for applications where silicones are prohibited, thus avoiding issues with silicone and low molecular weight siloxane migration. We recommend that compatibility tests be carried out on sensitive materials prior to large scale production. In all applications HTCPX_TRW will increase product quality, productivity, reduce maintenance costs and minimise rejects.

- Exceptionally high thermal conductivity; aids rapid heat dissipation over uneven surfaces
- Very high viscosity, offering stability under vibration; ideal for use as a gap filling material
- Based on a non-silicone oil; avoids issues with silicone and LMW siloxane migration
- Non-curing paste; allows simple and efficient rework of components if required

Approvals	RoHS-2 Compliant (2011/65/EU):	Yes
Typical Properties	Colour: Base: Flash Point of Base Oil: Thermo-conductive Component: Density @ 20°C (g/ml): Penetration: Thermal Conductivity (Heat flow): Thermal conductivity (Guarded Hot Plate) Temperature Range: Weight Loss after 96 hours @ 100°C:	Grey Blend of synthetic fluids > 280°C Powdered metal oxides 3.1 230-270 2.28 W/m.K 3.42 W/m.K (calculated) -50°C to +150°C < 1%
	Permittivity @ 10 ⁶ Hz: Specific Resistance: Dielectric Strength:	4.2 1 x 10 ¹⁴ Ohms/cm 42 kV/mm

<u>Description</u>	<u>Packing</u>	Order Code	Shelf Life
Heat Transfer Compound Plus – Xtra	700 gram cartridge	HTCPX700GTRW	48 months
TRW Grade	25 Kg Bulk	HTCPX25KTRW	72 months

Copyright Electrolube 2013

All information is given in good faith but without warranty. Properties are given as a guide only and should not be taken as a specification.

Electrolube cannot be held responsible for the performance of its products within any application determined by the customer, who must satisfy themselves as to the suitability of the product.

Ashby Park, Coalfield Way, Ashby de la Zouch, Leicestershire LE65 1JR T +44 (0)1530 419 600 F +44 (0)1530 416 640 BS EN ISO 9001:2008 Certificate No. FM 32082



Page 2

Directions for Use

HTCPX_TRW was developed as a thermally conductive gap filler. For gap filling applications the material can be dispensed either manually or via automated equipment into the desired location. The product should be tested to ensure the thickness of paste applied is suitable for the end application conditions. It should be noted that the thermally conductive pastes are just one layer in the system; dissipation from the heat generating source is achieved through many layers of different material before the heat is dissipated by free or forced convection. Therefore, a thermal paste will only aid the dissipation of heat if the interface where it is used has the lowest thermal conductivity within the system, i.e. is the rate determining step. The use of excess thermal paste will not offer an increase in the efficiency of heat transfer.

For other applications, HTCPX_TRW should be applied in the most appropriate manner for the application, avoiding any air inclusion and ensuring the product applied is as uniform as possible. A lower viscosity version of HTCPX is available if required (HTCPX-LV).

Additional Information

There are many methods of measuring thermal conductivity, resulting in large variances in results. Electrolube utilise a heat flow method which takes into account the surface resistance of the test substrate, thus offering highly accurate results of true thermal conductivity. Some alternative methods do not account for such surface resistance and can create the illusion of higher thermal conductivity. Therefore, when comparing thermal conductivity measurements it is important to know what test method has been utilised. For more information please contact the Electrolube Technical Department.

The rate at which heat flows is dependent on the temperature differential, the thickness and uniformity of the layer, and the thermal conductivity of the material. Products with the same comparable thermal conductivity value may have very different efficiencies of heat transfer in the end application depending on how successfully a thin even film can be applied.

A full range of heat transfer products are available from Electrolube: standard and high thermal conductivity pastes (HTC, HTCP), silicone based pastes for very high temperature applications (HTS), Silicone RTVs (TCOR, TCER), epoxy adhesives (TBS) and encapsulation resins (ER2220, UR5633, SC2003).

Revision 1: Oct 2013